

## CMOS 4-Bit Bidirectional Universal Shift Register

### High-Voltage Types (20 Volt Rating)

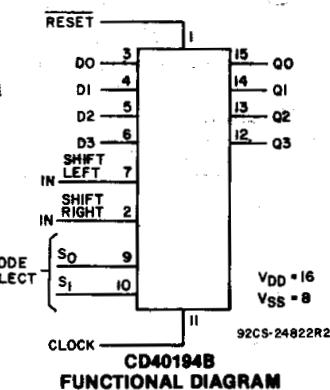
■ CD40194B is a universal shift register featuring parallel inputs, parallel outputs SHIFT RIGHT and SHIFT LEFT serial inputs, and a direct overriding clear input. In the parallel-load mode (S0 and S1 are high), data is loaded into the associated flip-flop and appears at the output after the positive transition of the CLOCK input. During loading, serial data flow is inhibited. Shift right and shift left are accomplished synchronously on the positive clock edge with data entered at the SHIFT RIGHT and SHIFT LEFT serial inputs, respectively. Clocking of the register is inhibited when both mode control inputs are low. When low, the RESET input resets all stages and forces all outputs low.

The CD40194B types are supplied in 16-lead dual-in-line plastic packages (E suffix), 16-lead small-outline packages (NSR suffix), and 16-lead thin shrink small-outline packages (PW and PWR suffixes).

#### MAXIMUM RATINGS, Absolute-Maximum Values:

DC SUPPLY-VOLTAGE RANGE, (V <sub>DD</sub> )	.....	-0.5V to +20V
Voltages referenced to V <sub>SS</sub> Terminal)	.....	-0.5V to +20V
INPUT VOLTAGE RANGE, ALL INPUTS	.....	-0.5V to V <sub>DD</sub> +0.5V
DC INPUT CURRENT, ANY ONE INPUT	.....	±10mA
POWER DISSIPATION PER PACKAGE (P <sub>D</sub> )	.....	
For T <sub>A</sub> = -55°C to +100°C	.....	500mW
For T <sub>A</sub> = +100°C to +125°C	.....	Derate Linearity at 12mW/°C to 200mW
DEVICE DISSIPATION PER OUTPUT TRANSISTOR	.....	
FOR T <sub>A</sub> = FULL PACKAGE-TEMPERATURE RANGE (All Package Types)	.....	100mW
OPERATING-TEMPERATURE RANGE (T <sub>A</sub> )	.....	-55°C to +125°C
STORAGE TEMPERATURE RANGE (T <sub>STG</sub> )	.....	-65°C to +150°C
LEAD TEMPERATURE (DURING SOLDERING):	.....	
At distance 1/16 ± 1/32 inch (1.59 ± 0.79mm) from case for 10s max	.....	+265°C

**NOT  
RECOMMENDED FOR  
NEW DESIGNS**



#### Features:

- Medium-speed: f<sub>CL</sub> = 12 MHz (typ.) @ V<sub>DD</sub> = 10V
- Fully static operation
- Synchronous parallel or serial operation
- Asynchronous master reset
- Standardized, symmetrical output characteristics
- 5-V, 10-V, and 15-V parametric ratings
- Meets all requirements of JEDEC Tentative Standard No. 13B, "Standard Specifications for Description of 'B' Series CMOS Devices"

#### Applications:

- Arithmetic unit bus registers
- Serial/parallel conversions
- General-purpose register for bus-organized systems
- General-purpose registers

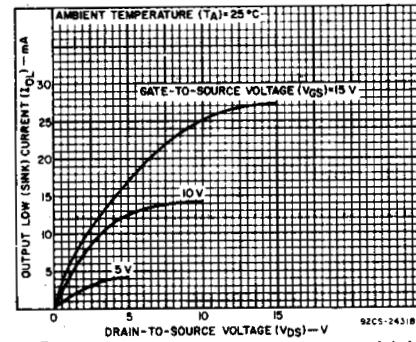


Fig. 1—Typical n-channel output low (sink) current characteristics.

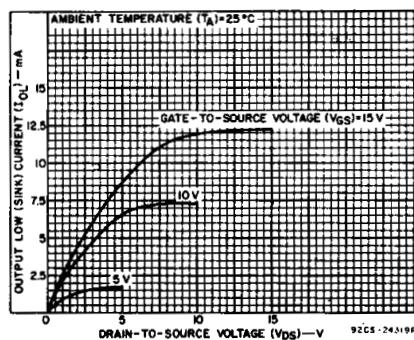


Fig. 2—Minimum n-channel output low (sink) current characteristics.

## CD40194B Types

**RECOMMENDED OPERATING CONDITIONS** at  $T_A = 25^\circ\text{C}$ , Except as Noted.  
For maximum reliability, nominal operating conditions should be selected so that operation is always within the following ranges:

CHARACTERISTIC	VDD (V)	LIMITS		UNITS
		Min.	Max.	
Supply-Voltage Range (For Package-Temperature Range)		3	18	V
Setup Time, $t_S$ D0, D3, SRIN, SLIN to clock	5 10 15	100 70 50	—	
SELECT 0, SELECT 1 to clock	5 10 15	400 220 130	—	ns
Hold Time, $t_H$ D0, D3, SRIN, SLIN to clock	5 10 15	0 0 0	—	
SELECT 0, SELECT 1 to clock	5 10 15	0 0 0	—	ns
Clock Pulse Width, $t_W$	5 10 15	180 80 50	—	
Clock Input Frequency $f_{CL}$	5 10 15	— — —	3 6 8	MHz
Clock Input Rise or Fall Time, $t_{rCL}, t_{fCL}$	5 10 15	1000 100 100	—	μs
Reset Pulse Width, $t_{WR}$	5 10 15	300 200 140	—	ns

### CONTROL TRUTH TABLE FOR CD40194B SERIES

CLOCK	MODE SELECT		RESET	ACTION
	S0	S1		
X	0	0	1	No Change
	1	0	1	Shift Right (Q0 toward Q3)
	0	1	1	Shift Left (Q3 toward Q0)
	1	1	1	Parallel Load
X	X	X	0	Reset

1 = High level  
0 = Low level

X = Don't care  
▲ = Level change

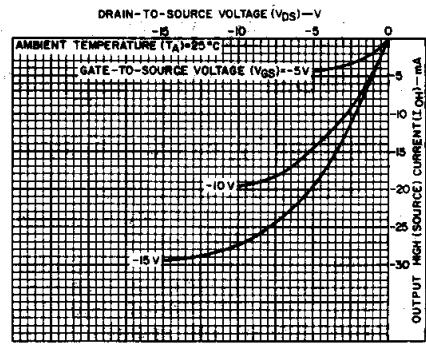


Fig. 3—Typical p-channel output high (source current characteristics).

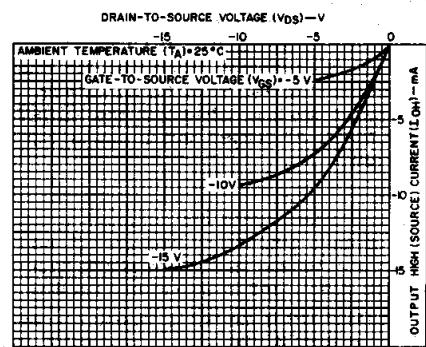


Fig. 4—Minimum p-channel output high (source current characteristics).

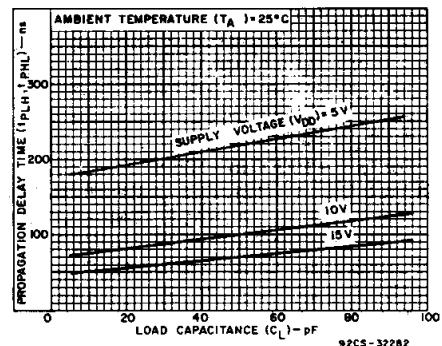


Fig. 5—Typical propagation delay time as a function of load capacitance, (CLOCK to Q).

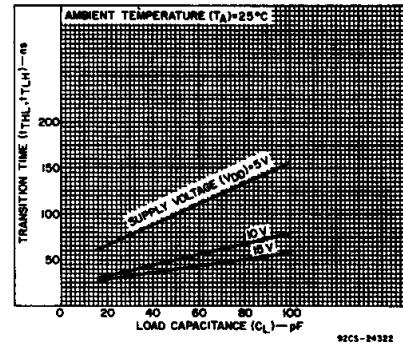


Fig. 6—Typical transition time as a function of load capacitance.

## CD40194B Types

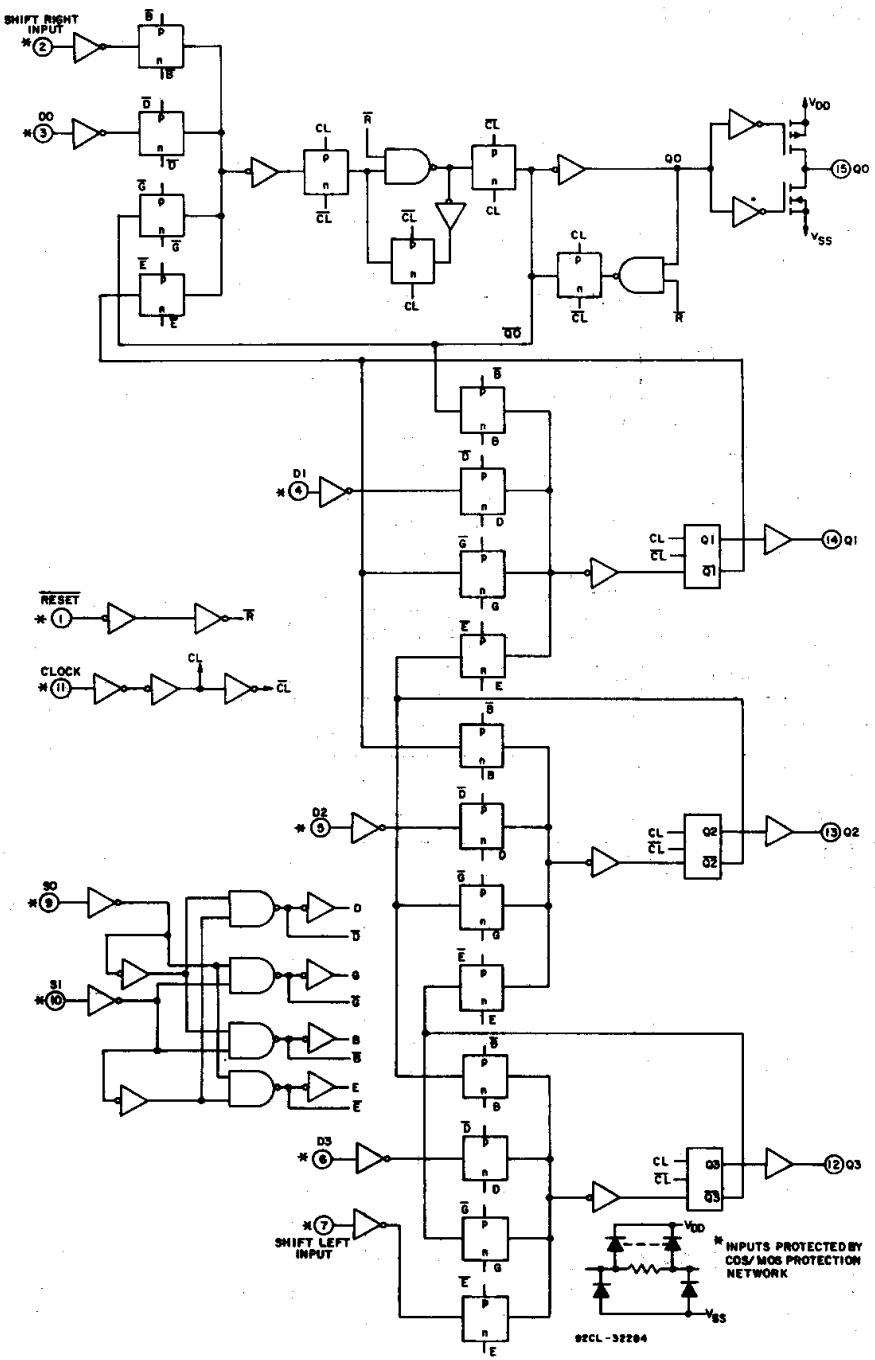


Fig. 8—CD40194B logic diagram.

## CD40194B Types

### STATIC ELECTRICAL CHARACTERISTICS

CHARACTERISTIC	CONDITIONS			LIMITS AT INDICATED TEMPERATURES (°C)								UNITS
				+25								
	$V_O$ (V)	$V_{IN}$ (V)	$V_{DD}$ (V)	-55	-40	+85	+125	Min.	Typ.	Max.		
Quiescent Device Current, $I_{DD}$ Max.	—	0.5	5	5	5	150	150	—	0.04	5		$\mu A$
	—	0.10	10	10	10	300	300	—	0.04	10		
	—	0.15	15	20	20	600	600	—	0.04	20		
	—	0.20	20	100	100	3000	3000	—	0.08	100		
Output Low (Sink) Current, $I_{OL}$ Min.	0.4	0.5	5	0.64	0.61	0.42	0.36	0.51	1	—		$mA$
	0.5	0.10	10	1.8	1.5	1.1	0.9	1.3	2.6	—		
	1.5	0.15	15	4.2	4	2.8	2.4	3.4	6.8	—		
Output High (Source) Current, $I_{OH}$ Min.	4.6	0.5	5	-0.64	-0.61	-0.42	-0.36	-0.51	-1	—		$mA$
	2.5	0.5	5	-2	-1.8	-1.3	-1.15	-1.6	-3.2	—		
	9.5	0.10	10	-1.6	-1.5	-1.1	-0.9	-1.3	-2.6	—		
	13.5	0.15	15	-4.2	-4	-2.8	-2.4	-3.4	-6.8	—		
Output Voltage: Low-Level, $V_{OL}$ Max.	—	0.5	5	0.05				—	0	0.05		$V$
	—	0.10	10	0.05				—	0	0.05		
	—	0.15	15	0.05				—	0	0.05		
Output Voltage: High-Level, $V_{OH}$ Min.	—	0.5	5	4.95				4.95	5	—		$V$
	—	0.10	10	9.95				9.95	10	—		
	—	0.15	15	14.95				14.95	15	—		
Input Low Voltage, $V_{IL}$ Max.	0.5, 4.5	—	5	1.5				—	—	1.5		$\mu A$
	1.9	—	10	3				—	—	3		
	1.5, 13.5	—	15	4				—	—	4		
Input High Voltage, $V_{IH}$ Min.	0.5, 4.5	—	5	3.5				3.5	—	—		$\mu A$
	1.9	—	10	7				7	—	—		
	1.5, 13.5	—	15	11				11	—	—		
Input Current $I_{IN}$ Max.	—	0.18	18	$\pm 0.1$	$\pm 0.1$	$\pm 1$	$\pm 1$	—	$\pm 10^{-5}$	$\pm 0.1$	$\mu A$	
3-State Output Leakage Current, $I_{OUT}$ Max.	0.18	0.18	18	$\pm 0.4$	$\pm 0.4$	$\pm 12$	$\pm 12$	—	$\pm 10^{-4}$	$\pm 0.4$	$\mu A$	

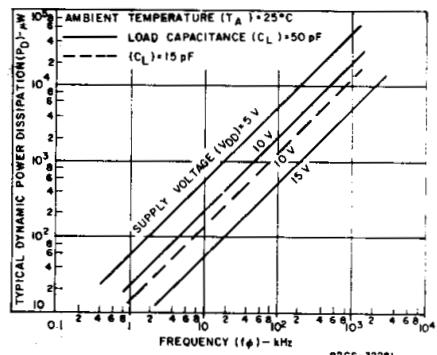


Fig. 9—Typical power dissipation as a function of frequency.

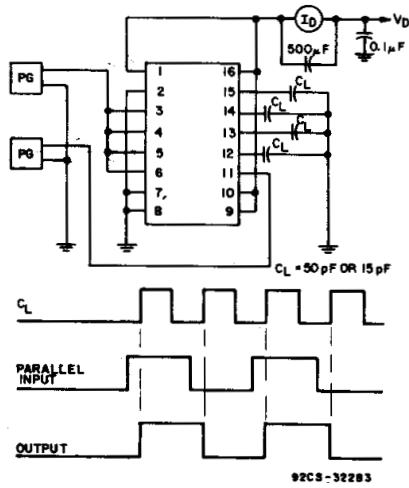


Fig. 10—Dynamic power dissipation test circuit.

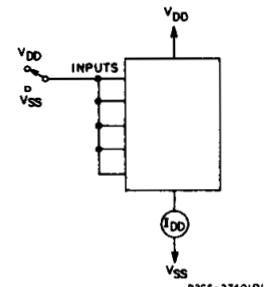


Fig. 11—Quiescent-device-current test circuit.

## CD40194B Types

DYNAMIC ELECTRICAL CHARACTERISTICS at  $T_A = 25^\circ\text{C}$ ,  
Input  $t_r, t_f = 20 \text{ ns}$ ,  $C_L = 50 \text{ pF}$ ,  $R_L = 200 \text{ k}\Omega$

CHARACTERISTIC	TEST CONDITIONS	LIMITS			UNITS
		V <sub>DD</sub> V	Min.	Typ.	
Propagation Delay Time: Clock to Q $t_{PHL}, t_{PLH}$	5	—	220	440	ns
	10	—	100	200	
	15	—	70	140	
Output Transition Time $t_{THL}, t_{TLH}$	5	—	100	200	ns
	10	—	50	100	
	15	—	40	80	
Minimum Setup Time: $t_S$ D0, D3, SR <sub>IN</sub> , SL <sub>IN</sub> to Clock	5	—	80	160	ns
	10	—	35	70	
	15	—	20	50	
SELECT 0, SELECT 1 to Clock	5	—	200	400	ns
	10	—	110	220	
	15	—	65	130	
Minimum Hold Time: $t_H$ D0, D3, SR <sub>IN</sub> , SL <sub>IN</sub> to Clock	5	—	—65	0	ns
	10	—	—25	0	
	15	—	—15	0	
SELECT 0, SELECT 1 to Clock	5	—	—170	0	ns
	10	—	—95	0	
	15	—	—55	0	
Minimum Clock Pulse Width $t_W$	5	—	90	180	ns
	10	—	40	80	
	15	—	25	50	
Maximum Clock Input Frequency $f_{CL}$	5	3	6	—	MHz
	10	6	12	—	
	15	8	15	—	
Maximum Clock Rise or Fall Time $t_{rCL}, t_{fCL}$	5	—	—	1000	$\mu\text{s}$
	10	—	—	100	
	15	—	—	100	
Minimum Reset Pulse Width* $t_{WR}$	5	—	150	300	ns
	10	—	100	200	
	15	—	70	140	
Reset Propagation Delay $t_{PRHL}$	5	—	230	460	ns
	10	—	90	180	
	15	—	65	130	
Input Capacitance $C_{IN}$	Any Input	—	5	7.5	pF

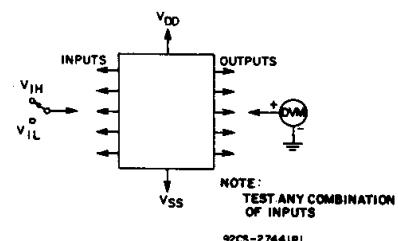


Fig. 12—Input-voltage test circuit.

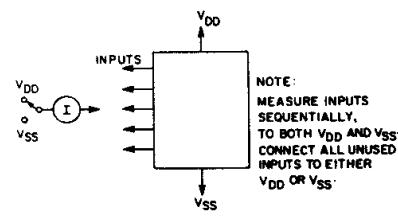
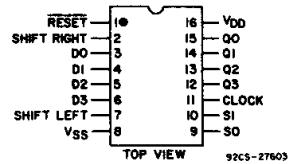


Fig. 13—Input current test circuit.

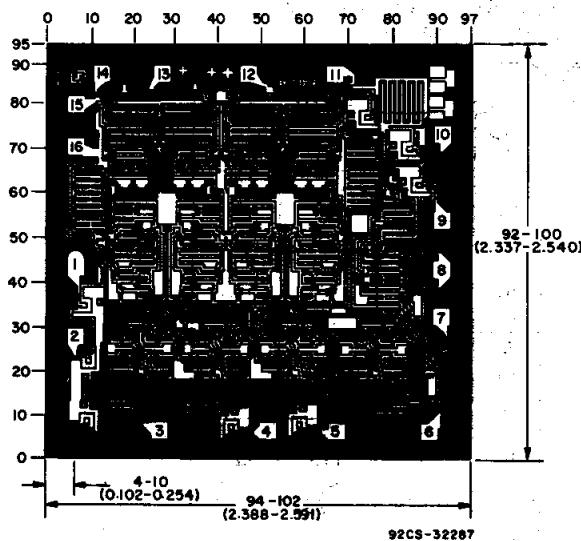
## TERMINAL DIAGRAM

### Top View



CD40194B

## CD40194B Types



Dimensions and pad layout for CD40194BH

Dimensions in parentheses are in millimeters and are derived from the basic inch dimensions as indicated. Grid graduations are in mils ( $10^{-3}$  inch).

**PACKAGING INFORMATION**

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead finish/ Ball material (6)	MSL Peak Temp (3)	Op Temp (°C)	Device Marking (4/5)	Samples
CD40194BE	ACTIVE	PDIP		N	16	25	RoHS & Green	NIPDAU	N / A for Pkg Type	-55 to 125	CD40194BE

(1) The marketing status values are defined as follows:

**ACTIVE:** Product device recommended for new designs.

**LIFEBUY:** TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

**NRND:** Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

**PREVIEW:** Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

(2) **RoHS:** TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

**RoHS Exempt:** TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

**Green:** TI defines "Green" to mean the content of Chlorine (Cl) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

(3) MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

(4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

(5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

(6) Lead finish/Ball material - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

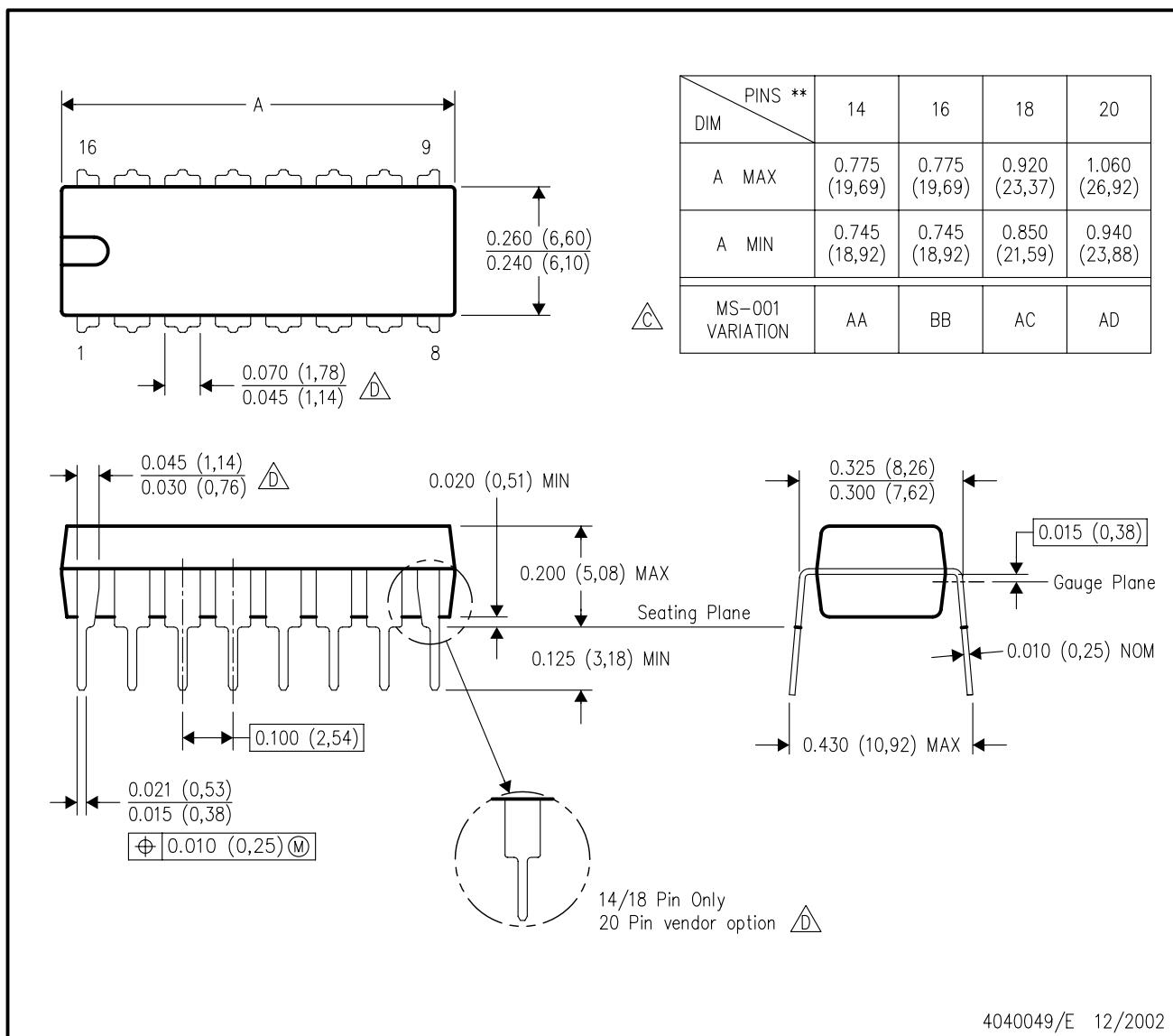
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## N (R-PDIP-T\*\*)

16 PINS SHOWN

## PLASTIC DUAL-IN-LINE PACKAGE



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